# sRPC: an RPC based on resistive MPGD technology



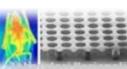
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<sup>1</sup>LNF- INFN <sup>2</sup> GERN









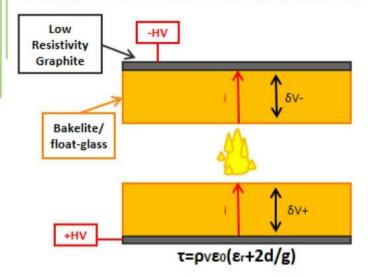


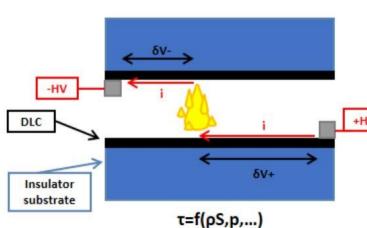






#### **Bulk RPC vs Surface RPC**





#### Classical RPC

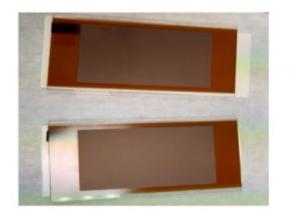
- Bulk resistivity electrodes (bakelite, float-glass, semiconductive glass, ... SI-GaAs)
- Recovery time proportional to volume resistivity, electrode thickness, gas gap
   τ=ρνεο(ε<sub>r</sub>+2d/g)
- Low volume resistivity and thin electrodes, together with the reduction of the gas gain (
   high gain low noise pre-amp) is the standard recipe to increase the detector rate capability

#### **Surface RPC**

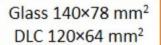
- Surface resistivity electrodes manufactured by sputtering Diamond-likecarbon (DLC) on flexible supports
- The technology allows to realize large electrodes with a surface resistivity in a very wide range: 10 M $\Omega$ / $\Box$  ÷ 10 G $\Omega$ / $\Box$
- High density current evacuation schemes, similar to those used for resistive MPGD (μ-RWELL and MicroMegas), can be implemented to improve the rate capability of the detector

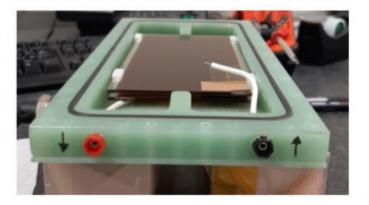
## **Prototype layout (I)**

- The baseline version of the detector is built with patterned DLC electrodes sputtered on Apical® foil then glued on float-glass substrates
- The glass support is used for mechanical purpose: excellent planarity and very smooth surface
- The 2 mm gas gap between the two electrodes is ensured by E-shaped spacers made of Delrin°
- The electrode stack is inserted in a FR4 box that acts as gas volume container









Patent: Brevetto-Italia N. 102020000002359 (submitted to INFN 10 Sept 2019 - registered at the patent office 6 Feb 2020) INFN – "ELETTRODO PIANO A RESISTIVITÀ SUPERFICIALE MODULABILE E RIVELATORI BASATI SU DI ESSO."

#### **Prototype layout (II)**

- The HV to DLC electrodes is supplied through a dot-like connection realized on DLC tails bent on the back side of the glass support
- External strip-patterned boards are used to pick-up the induced signals
- The readout is based on the six-channels VTX pre-amplifier with analog output, 10mV/fC sensitivity
- Detectors have been operated with the  $C_2H_2F_4/iso-C_4H_{10}/SF_6 = 93.5/5/1.5$  gas mixture





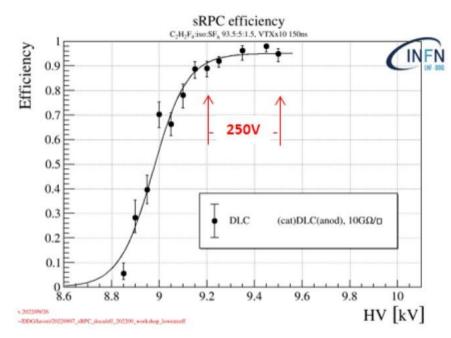


### The cathode puzzle (I)

The efficiency plateau is not as large as the one obtained with standard RPC with bulk resistivity electrodes ( $\geq 1 \text{kV}$ ).

Instability correlated with a constant current drawn has been observed over a certain HV threshold.

Since the DLC has a work function of few eV<sup>[1]</sup> and exhibits a non-negligible sensitivity to UV-photons<sup>[2]</sup>, secondary electron emission due to photon-feedback and/or field emission<sup>[3]</sup> may occur at the cathode surface.



Hypothesis: is the DLC cathode the source of the instability?

<sup>[1]</sup>A. Valentini, RD51-NOTE-2020-006.

<sup>[2]</sup> Kordas, et al., 15th Vienna Conference on Instrumentation, Feb. 18-22, 2019.

<sup>[3]</sup> S.A. Korff, Electron and Nuclear Counters, D. Van Nostrand Company -Inc, Fourth Avenue, New York, USA, 1955.

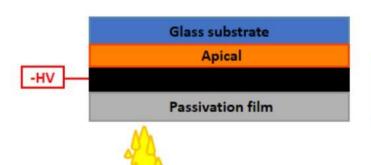
#### The Cathode Puzzle (III)

Possible solution: create a thin barrier on the cathode surface in order to suppress the electron extraction from DLC.

Several **passivation coatings** of the DLC cathode surface have been tested, among these the **Licron** led to positive results by significantly **improving the stability** of the detector.

In order to do not affect the correct behavior of the electrode, the passivation film should have a surface resistivity comparable with the DLC one.





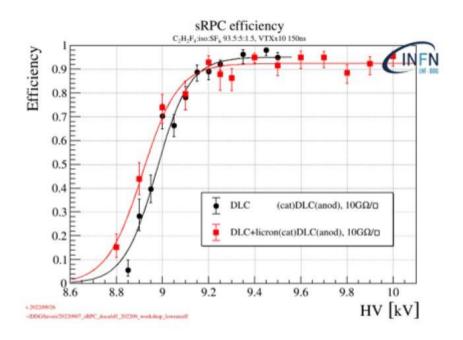
 $ho_{
m DLC} \sim 10^8 \div 10^9 \ \Omega/\Box$   $ho_{
m DLC} \sim 
ho_{
m film}$ 

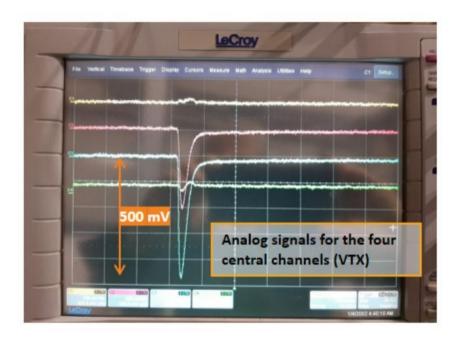
At the moment the cathode passivation is done manually. Looking for SBU technology.

#### Features / Benefits

- Rugged static dissipative coating
- Surface Resistivity of 10<sup>6</sup> To 10<sup>9</sup> ohms
- Operating temperature range up to 302°F (155°C)
- Humidity independent
- Superior adhesion to variety of surfaces: glass, plastic, etc.
- Coverage 1 gallon @ 1 mil wet film will cover ~1600 sq. ft., @ 2 mil ~800 sq. ft.
- Non-ozone depleting

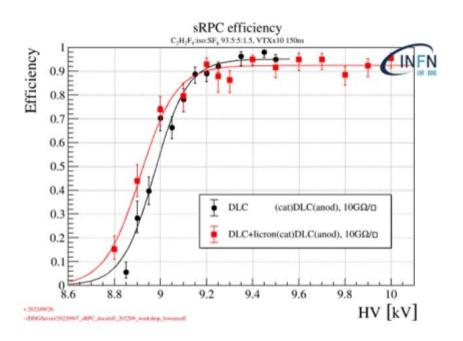
#### The Cathode Puzzle (IV)

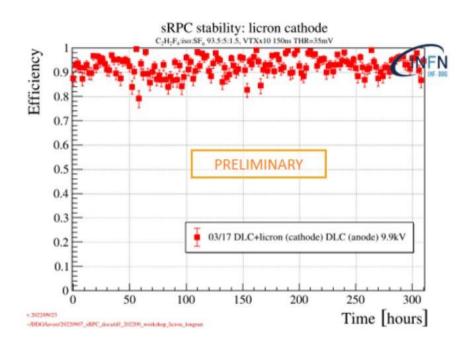




Detectors with **Licron** cathode passivation **show an efficiency plateau** of the order (or larger than) **of 1 kV**, while a long-term test to verify the detector stability is in progress.

#### The Cathode Puzzle – IV



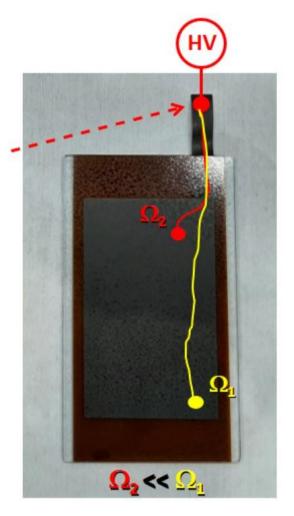


Detectors with **Licron** cathode passivation **show an efficiency plateau** of the order (or larger than) **of 1 kV**, while a long-term test to verify the detector stability is in progress.

## **Low-rate layout limitation**

A drawback of the surface resistivity electrode with single dot-like current evacuation scheme is that, beside the reduced capability to stand high particle fluxes, the detector response is not uniform over its surface.

This is more evident as the size of the detector increases. This effect is correlated to the average resistance ( $\Omega$ ) faced by the charge/current produced in the avalanche that depends on the distance between the particle incidence position and the current evacuation point on the electrode.

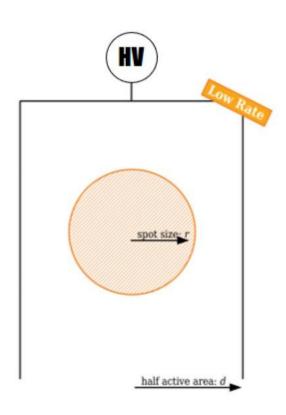


## **LR vs HR layout (1)**

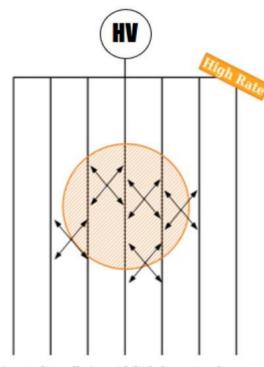
Exploiting the R&D on the  $\mu$ -RWELL, the solution could be the implementation of a "dense" conductive network on the resistive electrode.

In this way the average path of the current towards the evacuation connection is reduced thus improving the rate capability of the detector, as well as its response uniformity.

The **performance** of such a **HR layout** depends on the **DLC resistivity** as well as the **pitch of the conductive network**.



LR layout

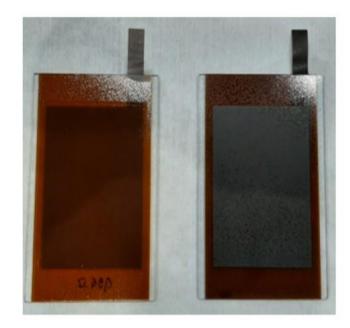


A sort of tassellation with little low rate schemes.

**HR** layout

## **LR vs HR layout (II)**

High-rate: same structure as Low-rate electrode ⊕ conductive grid acting as a fast current evacuation scheme



Low-rate: DLC sputtered on Apical® foil then glued on 2 mm thick float glass





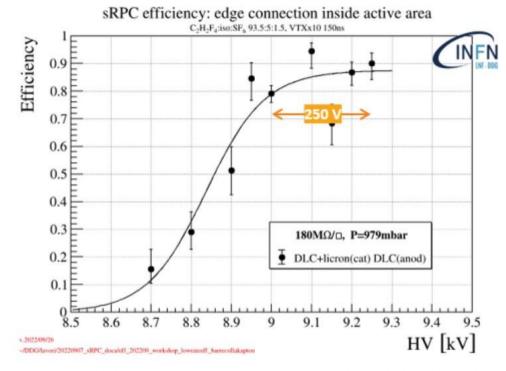
The conductive grid is realized by 1 mm wide screen-printed silver lines. A 5 mm wide solder-mask strip deposited on the silver lines ensures the insulation. Width and thickness of the solder-mask still to be optimized.

### High-rate layout: preliminary results (1)

soldermask







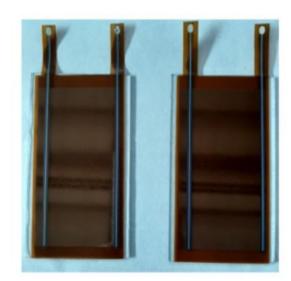
The implementation of **conductive lines** on the DLC, even though protected with solder-mask, **seems to introduce an instability at higher voltage**, sensibly reducing the plateau width w.r.t. the baseline version. The problem has **still to be solved** (solder-mask insulation, DOCA, etc ...)

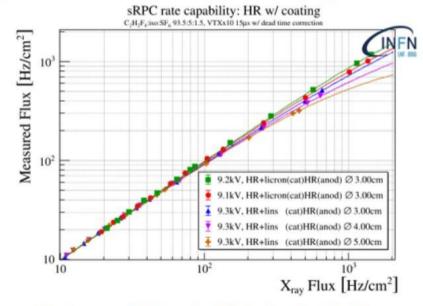
silver line

### High-rate layout: preliminary rate capability

A preliminary measurement of the rate capability (defined as the radiation flux corresponding to an efficiency drop of 20%) of the high-rate layout has been performed by irradiating the detector with a 5.9 keV X-ray gun with a spot size comparable with the pitch of the conductive grid realized on the DLC (1.6 GOhm/sq)



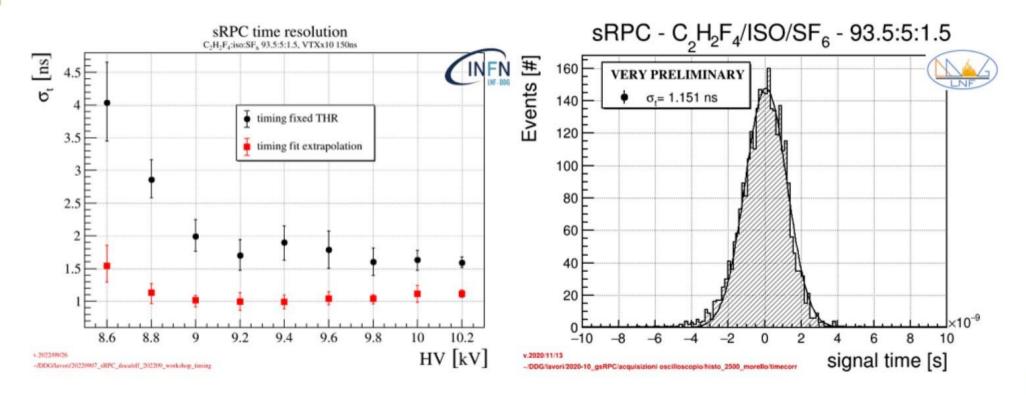




Layout still to be optimized (resistivity, grid-pitch, insulation ...)

Rate capability of  $\sim 1$  kHz/cm<sup>2</sup> with X-ray, corresponding to  $\sim 3$  kHz/cm<sup>2</sup> m.i.p.

#### **Time resolution**



 $\sigma_{\rm t} \sim 1 \, \rm ns \rightarrow typical \ for \ 2 \ mm \ gas \ gap \ RPC$ 

#### sRPC for thermal neutron detection (I)



#### Detecting thermal neutrons ( $E_k \sim 25 \text{meV}$ ) with sRPC:

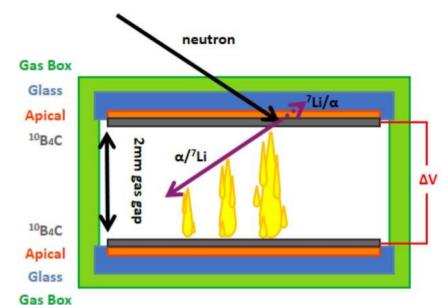
- <sup>10</sup>B<sub>4</sub>C deposition (\*) on one or both detector electrodes
- Neutron interacting with <sup>10</sup>B converts in back-to-back α/<sup>7</sup>Li

$$n + {}^{10}_{5}B \begin{cases} {}^{7}_{3}Li(1.02MeV) + \alpha(1.78MeV) & 6\% \\ {}^{7}_{3}Li(0.84MeV) + \alpha(1.47MeV) + \gamma(0.48MeV) & 94\% \end{cases}$$

2.5  $\mu$ m thick <sup>10</sup>B<sub>4</sub>C planar converter  $\rightarrow \sim 4\%$  neutron detection efficiency

#### Advantages of the device:

- simple technology → high efficiency multi-stack structure easy to be implemented
- scalable technology → exploitable for Radiation Portal Monitor (homeland security)

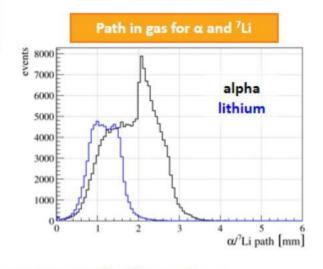


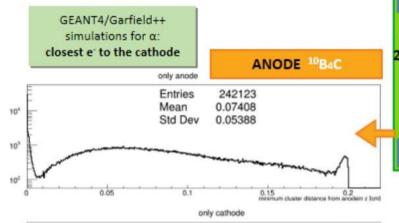
- $\alpha/7$ Li emission is **isotropic** ⇒ they enter the gas gap with a random angle
- $\alpha/7$ Li mean path is shorter than 2mm
  - ⇒ cathode and anode have different behaviour

(\*) see G. Morello's talk , 27/01 – micro-RWELL in HEP and beyond

## sRPC for thermal neutron detection: simulation





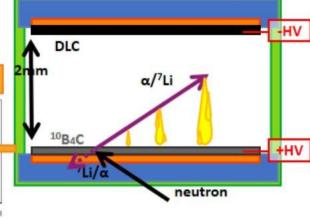


244593

6.006e-07

0.2

CATHODE 10 BaC



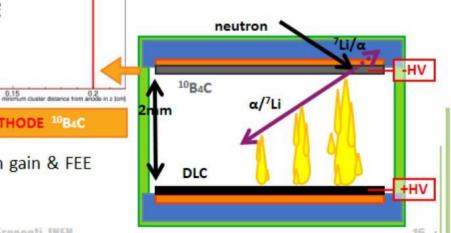
 RPC principle of operation: signal amplitude strongly depends on the distance of the ionization e from the cathode

mean path of α/<sup>7</sup>Li in gas ≤ gas gap

 $\Rightarrow \alpha/^7$ Li produced on the anode are harder to be detected than those generated on the cathode

**ANODE** <sup>10</sup>B<sub>4</sub>C: smaller and spread signal → efficiency strongly depends on gain & FEE threshold

CATHODE <sup>10</sup>B<sub>4</sub>C: every event has maximum amplification

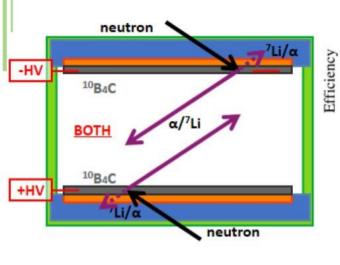


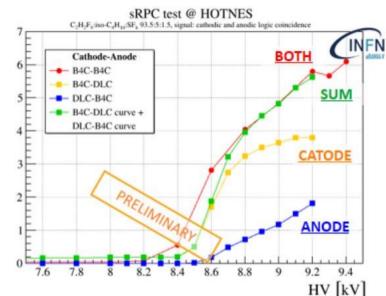
Entries

Std Dev

#### sRPC for thermal neutron detection (II)

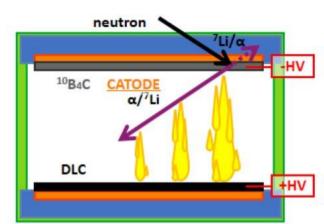


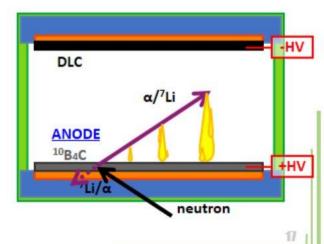




Measurements at HOTNES thermal neutron source w/three different layouts:

- ¹¹B₄C (Cat) DLC(An) → ~ 4% efficiency plateau achieved
- DLC (Cat) <sup>10</sup>B4C (An) → efficiency strongly depends on HV/gain
- ¹¹B₄C (Cat) ¹¹B₄C (An) → performs as the "SUM" of the two, reaching ~ 6% efficiency





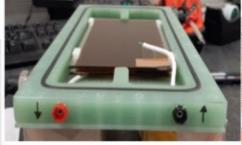
## **Summary & Outlook**

By exploiting the technology based on the **DLC sputtering** developed for **resistive MPGDs** we realized **electrodes** with **different surface resistivity** for a **new promising RPC concept** 

- The baseline version of the detector exhibits high stability (ΔV ≥ 1kV) and good performance in terms
  of efficiency (~95%) and time resolution (~1 ns)
- The High-rate version based on current evacuation schemes realized with conductive grids shows some instability, while a rate capability of ~3kHz/cm² with m.i.p, has been measured
  - > Optimization studies in terms of DLC resistivity, grid-pitch are the priorities for the near future
  - > Engineering studies, replacing glass support with standard PCB (SBU tech.) will be performed
- The DLC sputtering is a scalable technology allowing to realize large area electrodes at low cost: the CERN-INFN DLC (CID) sputtering facility will allow the manufacturing of ~2x0.5 m DLC foils
- Very promising results with boron coated sRPC have been achieved, opening the way for a cost effective - scalable thermal neutron detector technology (for homeland security application)









## MANY THANKS



















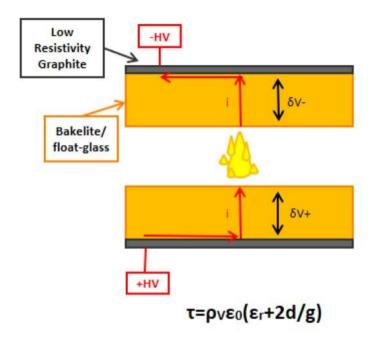




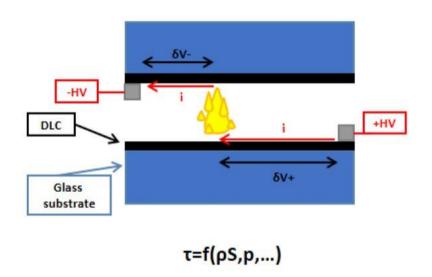


## **Spare slides**

#### **Bulk RPC vs surface RPC**



The graphite layer is coated(O(1 MOhm/ $\square$ ) on the back of the resistive electrode with the aim to supply the HV. The voltage drop across the bulk electrode is  $\delta V+\oplus \delta V$ , does not depend on the incidence position. The two contributions are equal.



The voltage drop on the DLC surface,  $\delta V+ \oplus \delta V$ -, depends on the distance between the event and the ground connection. The two contributions can be very different, while their sum is roughly constant.

## sRPC – evolution from the first prototype

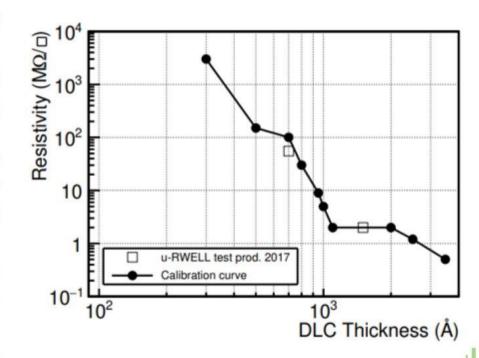
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G. Bencivenni et al., The surface Resistive Plate Counter: An RPC based on resistive MPGD technology, Nucl. Instrum. Meth. A 1046 (2023) 167728 G. Bencivenni et al., The surface Resistive Plate Counter: An new RPC based on resistive MPGD technology, Nucl. Instrum. Meth. A 1038 (2022) 166948 sRPC using glass instead of FR4: Refined work gsRPC from CERN PCB workshop 2mm o≈1GΩ/□ gas gap First homemade prototypes

G. Bencivenni - Laboratori Nazionali di Frascati. INFN

#### **Diamond Like Carbon**

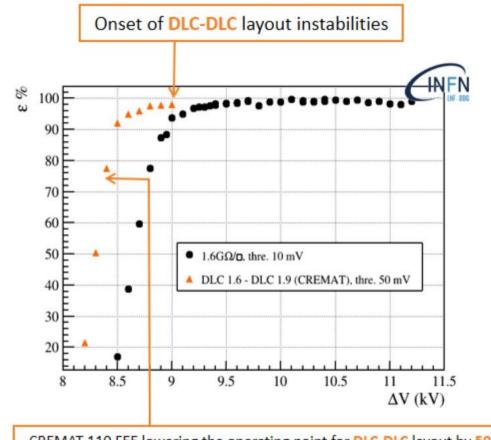
- The DLC sputtering technology is used in many industrial applications (mechanics, automotive and medical industry) that require surface hardening and reduced abrasive wear
- The DLC is a class of carbon material that contains both diamond as well as graphite structure in different fractions, depending on sputtering parameters
- The DLC film (typically 0.1 μm thick) is deposited by sputtering graphite on one side of a large Apical® foil. The resistivity depends on the DLC thickness and gas atmosphere (Ar, N<sub>2</sub>, C<sub>2</sub>H<sub>2</sub>) used in the process
- The production of DLC Apical® foils for detectors (μ-RWELL, MicroMegas, sRPC) has been done by the Be-Sputter Co., Ltd. in Japan (size ~1.2x0.6 m²)
- A DLC machine, co-funded by CERN and INFN, is going to enter in operation at the CERN MPT- Workshop (size ~2x0.6 m²)



#### The Cathode Puzzle (II)

#### Hybrid layout: float glass cathode – DLC anode

- Detector shows high stability (efficiency plateau larger than 2kV)
- Float glass cathodes don't show of photonfeedback or field emission effects
- Not a solution for high-rate because limited by the relatively high resistivity of the float glass

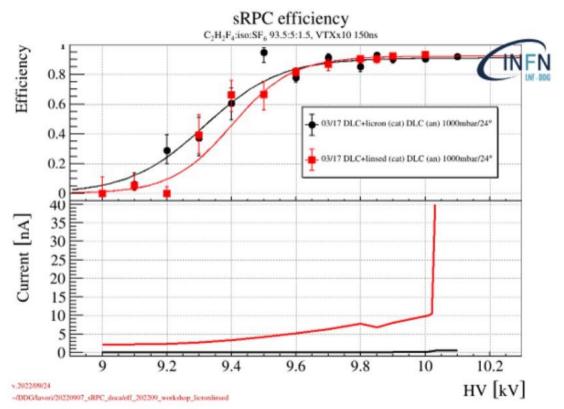


CREMAT 110 FEE lowering the operating point for DLC-DLC layout by 500V

#### Linsed-oil vs Licron (dot-like HV connection)

Main differences between linsed-oil and Licron:

- P<sub>linsed-oil</sub> >> P<sub>Licron</sub>
- Licron is easier to apply/engineering
- Detectors with DLC cathode passivated with linsed-oil show dark current and breakdown at high voltage



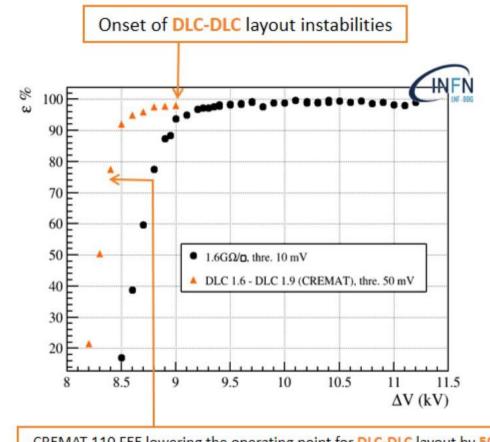
#### The Cathode Puzzle – II

#### Symmetrical layout: DLC cathode – DLC anode

- Detector shows instability at higher voltage
- possible photon-feedback or/and field emission effects on the DLC surface of the cathode
- with more sensitive electronics few hundreds of Volts of stable operation can be achieved

#### Hybrid layout: float glass cathode - DLC anode

- Detector shows high stability (efficiency plateau larger than 2kV)
- Float glass cathodes don't suffer of photon-feedback or field emission effects
- Not a solution for high-rate because limited by the relatively high resistivity of the float glass



CREMAT 110 FEE lowering the operating point for DLC-DLC layout by 500V

## urania $\rightarrow$ thermal neutron detection w/ $\mu$ -RWELL



micro

R esistive

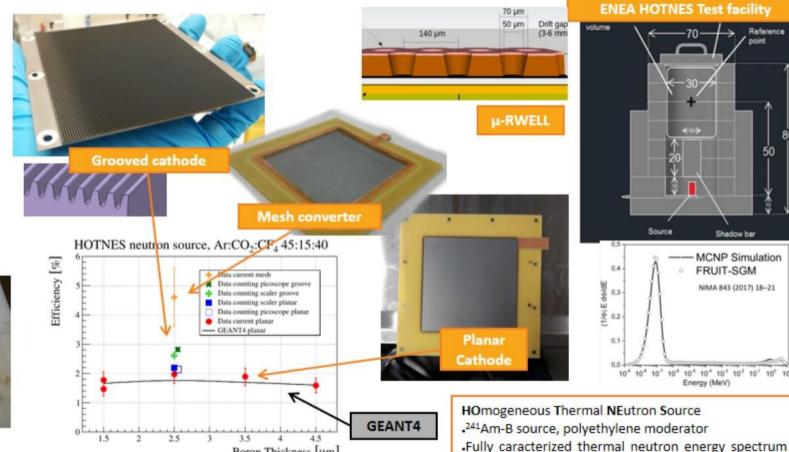
dvanced

eutron N

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and fluence

Boron Thickness [µm]

### urania $\rightarrow$ thermal neutron detection w/ $\mu$ -rwell



u micro

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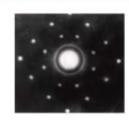
A pparatus

#### WHY

- Probing heavy structure in motion
- High penetration power
- High sensitivity and selectivity
- Unique probe
- for magnetism
- for fundamental properties
- Radioactive waste monitoring
- Radiation Portal Monitor (homeland security)
- Neutron diffraction imaging

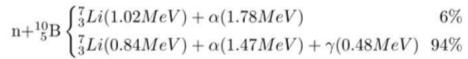
#### HOW

- · High energy: Hadron Calorimeter
- Measure energy deposited in form of hadronic shower
- · Moderate energy: np-Scattering
- Scattering with protons from H-materials
- Low Energy: Exo-energetic Nuclear Processes
- · Use converter medium with large capture cross-section

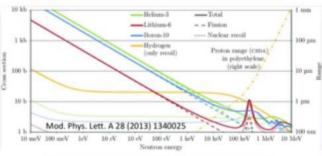








Goal – Detection of thermal neutrons ( $E_k \sim 25 meV$ ):  $^{10}B_4C$  deposition on  $\mu$ -RWELL cathode, conversion to ionizing Particle ( $\alpha/^7Li$  back to back  $\rightarrow$  mutually esclusive events). Not negligible  $\alpha/^7Li$  cross-section with  $^{10}B_4C \rightarrow$  thickness optimization.



Cross section for common conversion materials